#### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Masahiro SUNOHARA, et al.

Serial Number: Not Yet Assigned

Filed: January 14, 2004

For: ELECTRONIC PARTS PACKAGING STRUCTURE AND METHOD OF

MANUFACTURING THE SAME

#### INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

January 14, 2004

Sir:

In compliance with 37 CFR 1.56, Applicants call to the attention of the Patent and Trademark Office the references listed on the attached PTO-1449.

A copy of each of the references, except for the U.S. patent publication, is enclosed herewith.

In the event there are any fees due in connection with the filing of this paper, please charge Deposit Account No. <u>01-2340</u>.

Respectfully submitted,

ARMSTRONG, KRATZ, QUINTOS,

HANSON & PROONS, LLP

Mel R. Quintos
Attorney for Applicants
Reg. No. 31,898

MRQ/jaz Atty. Docket No. **040001** Suite 1000 1725 K Street, N.W. Washington, D.C. 20006 (202) 659-2930

PATENT TRADEMARK OFFICE

Enclosures: PTO-1449; References (2)

| INFORMATION DISCLOSURE STATEMENT | Atty. Docket No. 040001                 | Serial No. New Application       |
|----------------------------------|---|----------------------------------|
|                                  | Applicant(s): Masahiro SUNOHARA, et al. |                                  |
| PTO-1449                         | Filing Date: January 14, 2004           | Group Art Unit: Not Yet Assigned |

## **U.S. PATENT DOCUMENTS**

| Examiner<br>Initial |    | Document No.    | Name              | Date     | Cla<br>ss | Subclass | Filing Date<br>(If<br>appropriate) |
|---------------------|----|-----------------|-------------------|----------|-----------|----------|------------------------------------|
|                     | AA | 2001/0004130 A1 | M. Higashi et al. | 06/21/01 |           |          |                                    |
| ·                   | AB |                 |                   |          |           |          |                                    |
|                     | AC |                 |                   |          |           |          |                                    |
|                     | AD |                 |                   | •        |           |          |                                    |

# FOREIGN PATENT DOCUMENTS

|        | Document<br>No. | Date     | Country | Translation (Yes or No)  |
|--------|-----------------|----------|---------|--|
| <br>AE | 2001-177045     | 06/29/01 | Japan   | No-Corresponds to USP 2001/0004130 A1/Discussed in the specification |
| <br>AF | 2000-323645     | 11/24/00 | Japan   | Yes-Abstract/Discussed in the specification                          |
| <br>AG |                 |          |         |  |
| <br>AH |                 |          |         | , 1  |
| AI     |                 |          |         |  |

## OTHER DOCUMENTS

| <u></u>  | AJ |                 |
|----------|----|-----------------|
|          | AK |                 |
| Examiner |    | Date Considered |